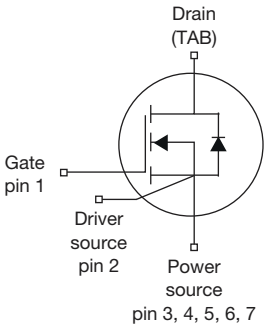
MaxSiC® 1200 V N-Channel SiC MOSFET

D²PAK 7L (TO-263 7L)

Top View



Marking Code: Q120A063SE

FEATURES

- AEC-Q101 qualified
- Fast switching speed
- Short circuit withstand time 3 µs
- Material categorization:
  for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE

RoHS COMPLIANT

HALOGEN FREE

APPLICATIONS

- Automotive on board charger
- Automotive DC/DC converter for EV/HEV
- Auxiliary drives
- EV Charging

PRODUCT SUMMARY		
V_{DS} (V) at T_J max.	1200	
$R_{DS(on)}$ typ. (mΩ) at 25 °C	V_{GS} = 18 V	63
Q_g typ. (nC)	58	
I_D (A)	41	
C_{oss} typ. (pF)	69	
P_D (W)	221	
Configuration	Single	

ORDERING INFORMATION	
Package	D²PAK 7L (TO-263 7L)
Lead (Pb)-free and halogen-free	MXPQ120A063SE-1GE3

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)				
PARAMETER		**SYMBOL**	**LIMIT**	**UNIT**
Drain-source voltage		V_{DS}	1200	V
Gate-source voltage		V_{GS}	-10 / +22	
Recommended operation voltage of gate-source		V_{GSOP}	-5 to -3 / +18	
Continuous drain current	T_C = 25 °C	I_D	41	A
Pulsed drain current [a]		I_{DM}	82	
Short-circuit withstand time [b]		T_{SC}	3	µs
Maximum power dissipation	T_C = 25 °C	P_D	221	W
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +175	°C
Soldering recommendations (peak temperature)	For 10 s		260	°C
Single pulse avalanche energy [c]		E_{AS}	162	mJ

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature
b. V_{GS} = 18 V, V_{DS} = 800 V, $R_{g(ext)}$ = 20 Ω, verified by the design / characterization
c. T_J = 25 °C, V_{DD} = 120 V, L = 1 mH, V_{GS} = 18 V, I_{AS} = 18 A, verified by the design / characterization

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THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R_{thJA}	-	40	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	0.68	

SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V_{DS}	V_{GS} = 0 V, I_D = 1 mA		1200	-	-	V
Gate-source threshold voltage (N)	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 3.5 mA		-	2.9	-	V
		V_{DS} = V_{GS}, I_D = 3.5 mA, T_J = 175 °C		-	2.0	-	V
Gate-source leakage	I_{GSS}	V_{GS} = 22 V, V_{DS} = 0 V		-	-	100	nA
		V_{GS} = -10 V, V_{DS} = 0 V		-	-	-100	
Zero gate voltage drain current	I_{DSS}	V_{DS} = 1200 V, V_{GS} = 0 V		-	-	10	µA
Drain-source on-state resistance	$R_{DS(on)}$	V_{GS} = 15 V, I_D = 18 A		-	75	94	mΩ
		V_{GS} = 18 V, I_D = 18 A		-	63	79	
		V_{GS} = 18 V, I_D = 18 A, T_J = 175 °C		-	107	-	
Transconductance	gfs	V_{DS} = 10 V, I_D = 18 A		-	8	-	S
Dynamic							
Input capacitance	C_{iss}	V_{GS} = 0 V, V_{DS} = 800 V, f = 100 KHz		-	1699	-	pF
Output capacitance	C_{oss}			-	69	-	
Reverse transfer capacitance	C_{rss}			-	3	-	
Total gate charge	Q_g	V_{GS} = -5 V ~ 18 V, I_D = 18 A, V_{DS} = 800 V		-	58	-	nC
Gate-source charge	Q_{gs}			-	16	-	
Gate-drain charge	Q_{gd}			-	16	-	
Gate Resistance	R_g	V_{DS} = 0 V, f = 1 MHz		-	3	-	Ω
Switching Characteristics							
Turn-on delay time	$t_{d(on)}$	V_{GS} = -5 V ~ 18 V, I_D = 18 A, V_{DS} = 800 V, $R_{g(ext)}$ = 4.4 Ω	T_J = 25 °C	-	18	-	ns
			T_J = 175 °C	-	18	-	
Rise time	t_r		T_J = 25 °C	-	9	-	
			T_J = 175 °C	-	8	-	
Turn-off delay time	$t_{d(off)}$		T_J = 25 °C	-	19	-	
			T_J = 175 °C	-	20	-	
Fall time	t_f		T_J = 25 °C	-	10	-	
			T_J = 175 °C	-	10	-	
Turn-on switching energy	E_{on}		T_J = 25 °C	-	191	-	µJ
			T_J = 175 °C	-	178	-	
Turn-off switching energy	E_{off}		T_J = 25 °C	-	51	-	
			T_J = 175 °C	-	50	-	
Body Diode Ratings and Characteristic							
Forward diode voltage	V_{SD}	V_{GS} = -5 V, I_{SD} = 9 A, T_J = 25 °C		-	4.8	-	V
Continuous diode forward current	I_{SD}	V_{GS} = -5 V, T_J = 25 °C		-	-	33	A
Pulsed diode forward current	I_{SDM}			-	-	82	
Reverse recovery time	t_{rr}	V_{GS} = -5 V, I_{SD} = 18 A, V_R = 800 V, di/dt = 1000 A/µs		-	18	-	ns
Reverse recovery charge	Q_{rr}			-	60	-	nC
Reverse recovery current	I_{RRM}			-	6	-	A

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

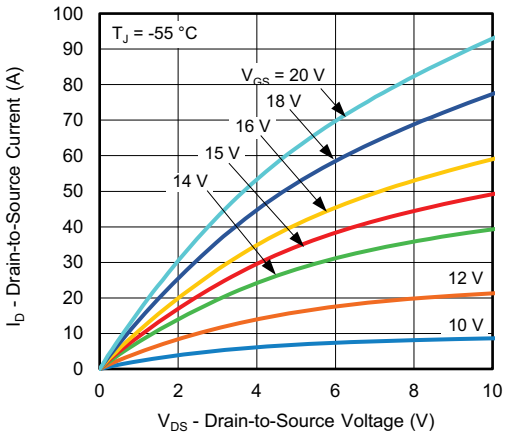

Fig. 1 - Typical Output Characteristics

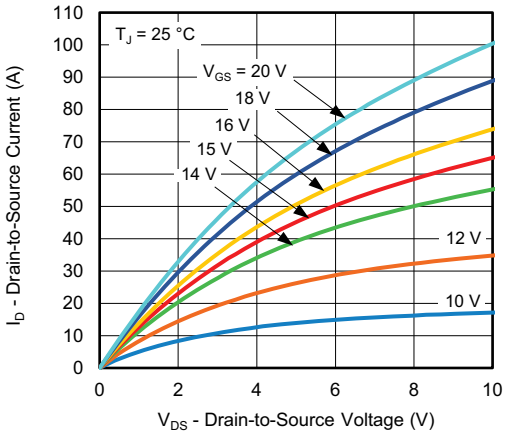

Fig. 2 - Typical Output Characteristics

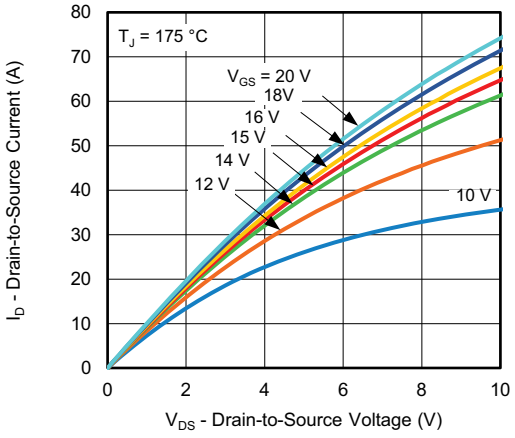

Fig. 3 - Typical Output Characteristics

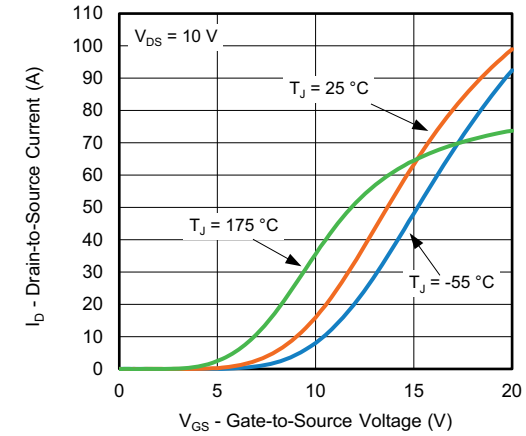

Fig. 4 - Typical Transfer Characteristics

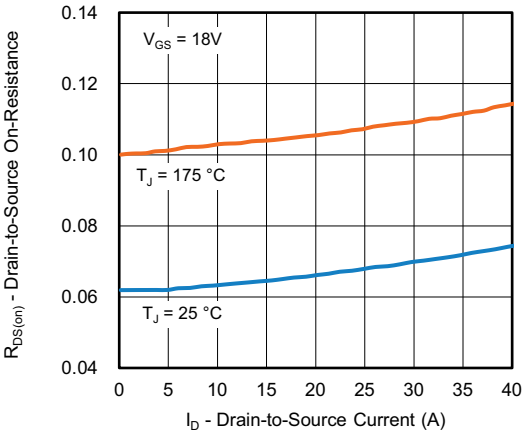

Fig. 5 - Normalized On-Resistance vs. Drain Current

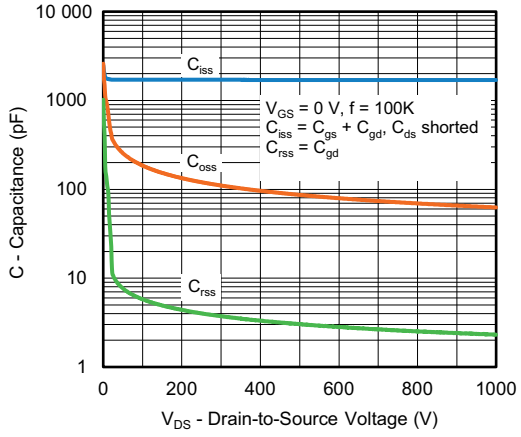

Fig. 6 - Typical Capacitance vs. Drain-to-Source Voltage

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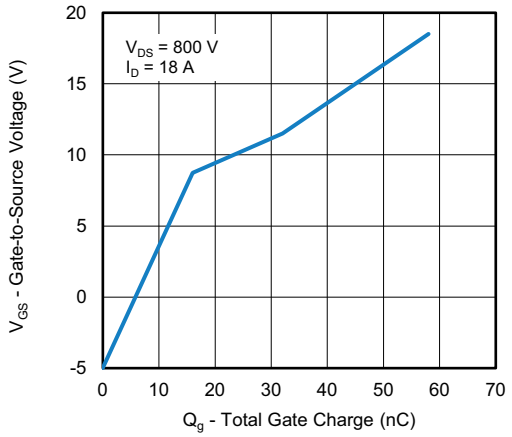

Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

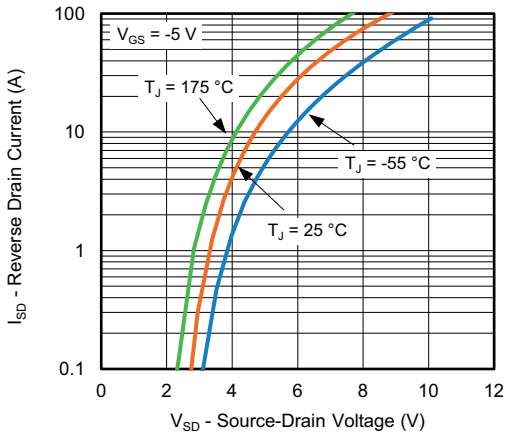

Fig. 10 - Typical Source-Drain Diode Forward Voltage

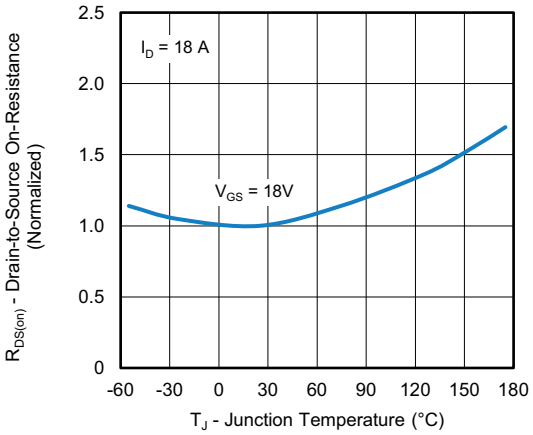

Fig. 8 - Normalized On-Resistance vs. Temperature

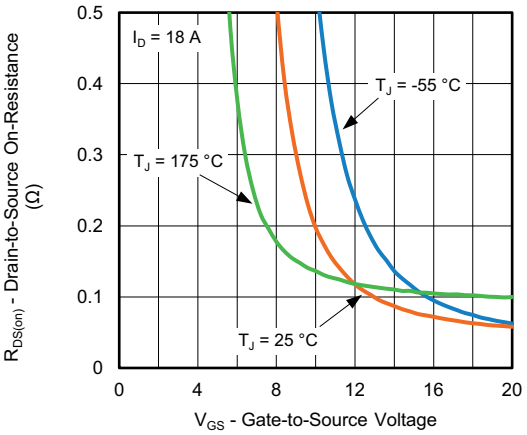

Fig. 11 - On-Resistance vs. Gate-to-Source Voltage

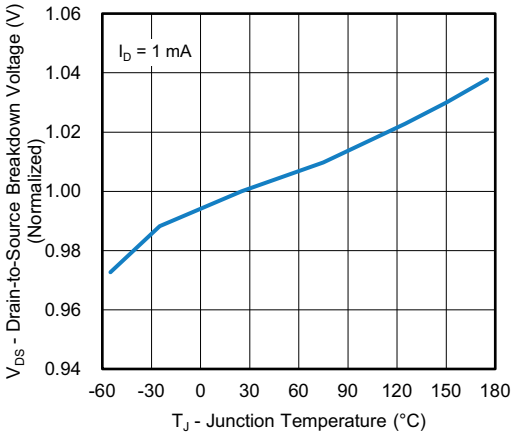

Fig. 9 - Drain-to-Source Voltage vs. Temperature

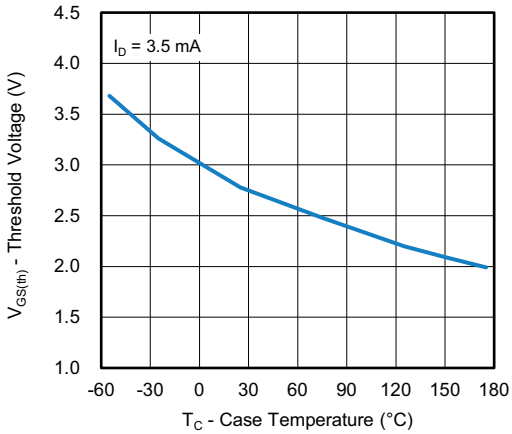

Fig. 12 - Threshold Voltage vs. Case Temperature

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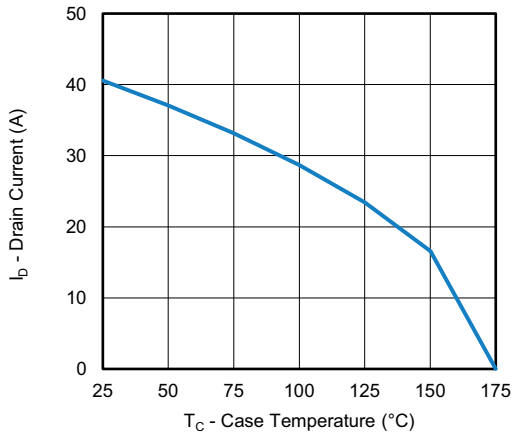

Fig. 13 - Drain Current vs. Case Temperature

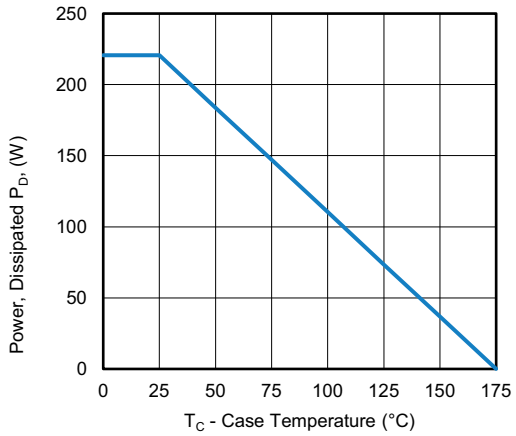

Fig. 15 - Power, Dissipated P_D vs. Case Temperature

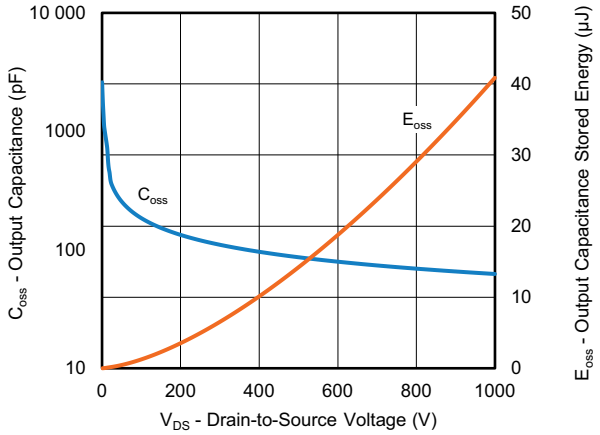

Fig. 14 - Output Capacitance and its Stored Energy vs. Drain-to-Source Voltage

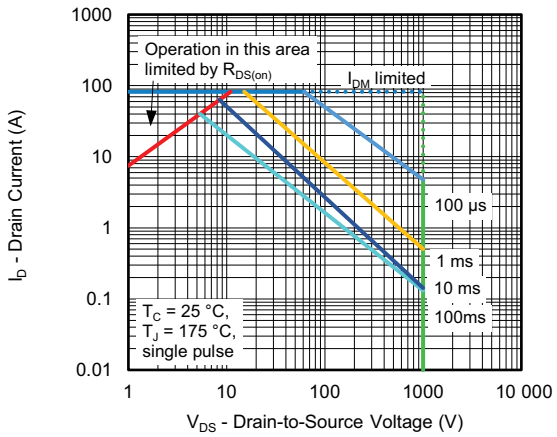

Fig. 16 - Safe Operating Area

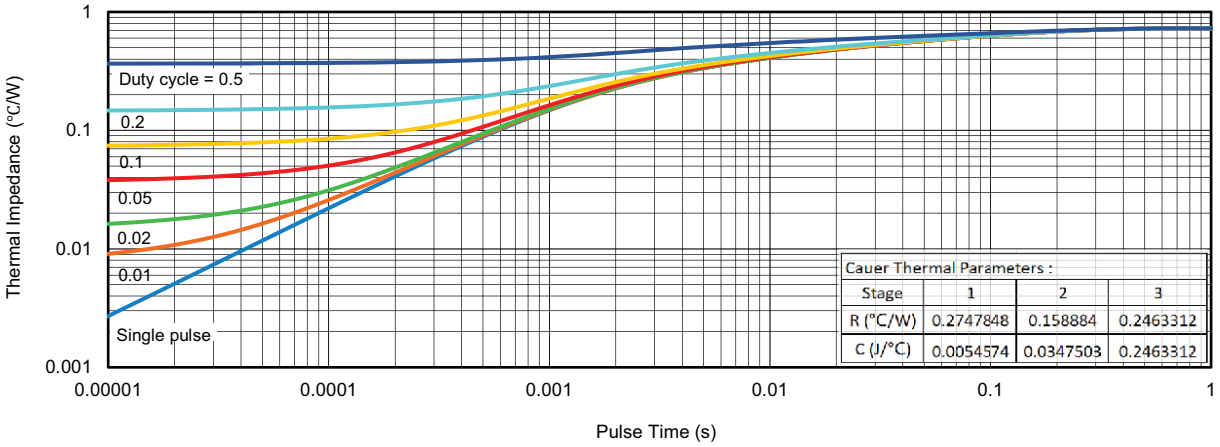

Fig. 17 - Transient Thermal Impedance

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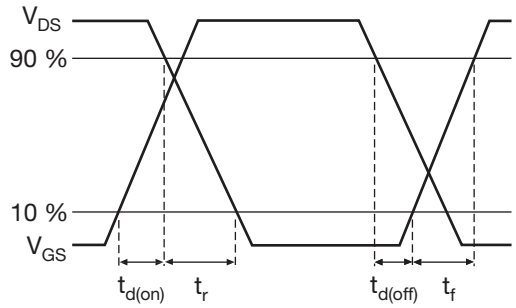

Fig. 18 - Waveforms of Switching Time

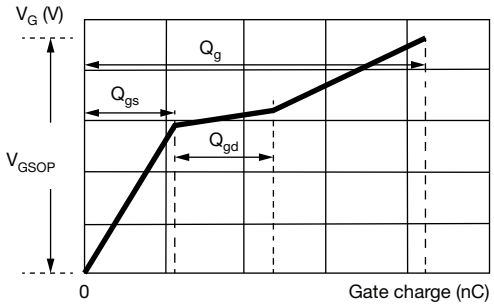

Fig. 21 - Waveforms for Gate Charge

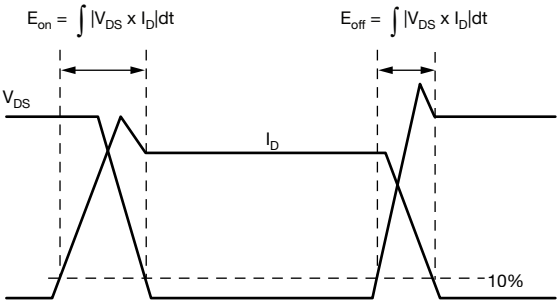

Fig. 19 - Waveforms for Switching Energy

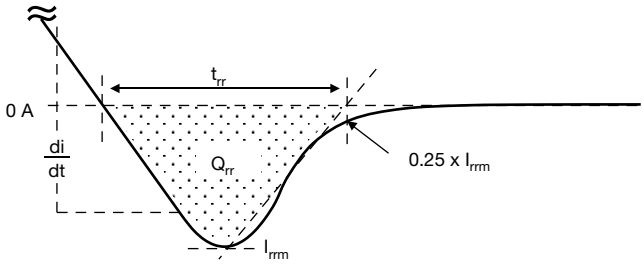

Fig. 22 - Waveforms for Reverse Recovery

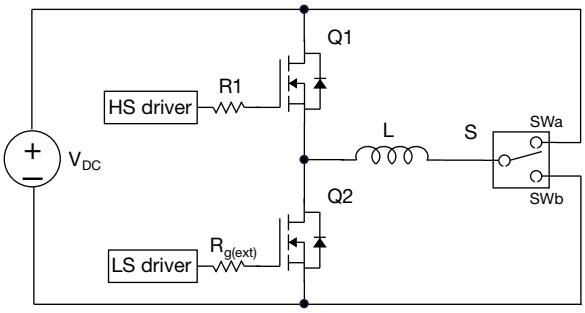

Fig. 20 - Switching and Reverse Diode Characteristics Measurement Circuit

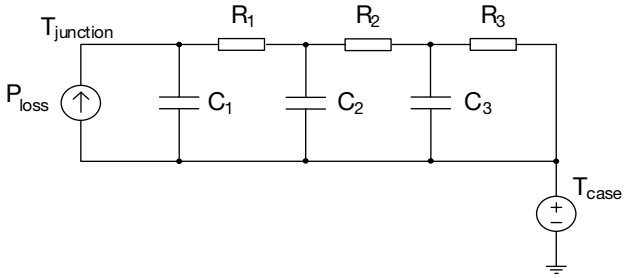

Fig. 23 - Thermal Equivalent Circuit

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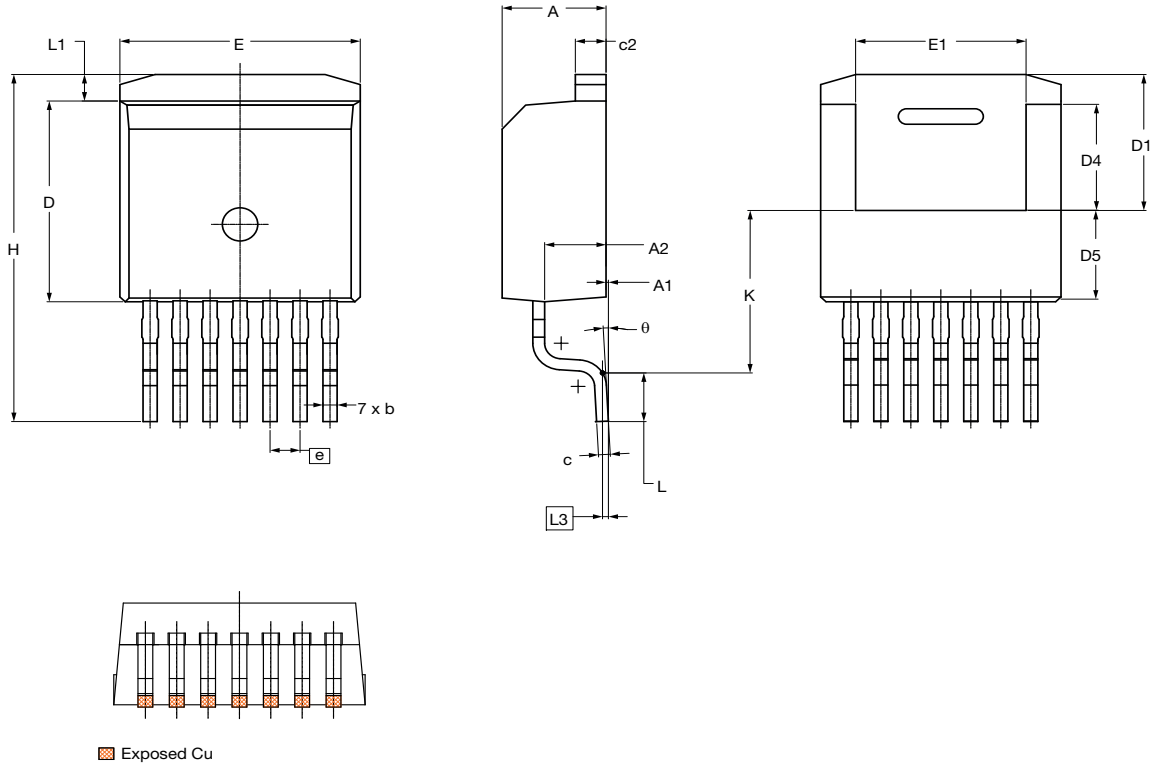
Case Outline for TO-263 7L Package

FACILITY CODE: 9



DIM.	MILLIMETERS		
	MIN.	NOM.	MAX.
A	4.30	4.40	4.50
A1	0.00	0.10	0.25
A2	2.45	2.60	2.75
b	0.50	0.60	0.70
c	0.45	0.50	0.60
c2	1.20	1.30	1.40
D	8.93	9.08	9.23
D1		6.15 ref.	
D4	4.65	4.80	4.95
D5	3.83	4.13	4.43
E	10.08	10.18	10.28
E1	6.82	7.22	7.62
e		1.27 BSC.	
H	15.00	15.70	16.00
K		7.30	
L	1.90	2.20	2.50
L1	1.00	1.20	1.40
L3		0.25 BSC.	
θ	0 °	3 °	7 °
ECN: S25-0851-Rev. C, 18-Jul-2025 DWG: 6119			

Notes

- All dimensions are in mm and angles are in degrees
- Dimension D and E do not include mold flash. These dimensions are measured at the outermost extreme of the plastic body
- Thermal pad contour optional within Dimensions E, L1, D4 and E1
- Dimension D4 and E1 establish a minimum mounting surface for the thermal pad
- There is exposed Cu and molding flash bleeding at the pin which is close to package

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